

1 **DECLARATION OF SOLE INVENTOR FOR PATENT APPLICATION**

2 As the below named inventor, I hereby declare that:

3 My residence, post office address and citizenship are as stated
4 below next to my name.

5 I believe I am the original, first and sole inventor of the subject
6 matter which is claimed and for which a patent is sought on the
7 invention entitled: Circuitry Comprising Roughened Platinum Layers,
8 Platinum-Containing Materials, Capacitors Comprising Roughened Platinum
9 Layers, Methods Of Forming Roughened Layers Of Platinum, And
10 Methods Of Forming Capacitors, the specification of which is attached
11 hereto.

12 I hereby state that I have reviewed and understand the contents
13 of the above-identified specification, including the claims.

14 I acknowledge the duty to disclose information known to me to
15 be material to patentability as defined in Title 37, Code of Federal
16 Regulations §1.56.

17 **PRIOR FOREIGN APPLICATIONS:**

18 I hereby state that no applications for foreign patents or inventor's
19 certificates have been filed prior to the date of execution of this
20 declaration.

21 I hereby declare that all statements made herein of my own
22 knowledge are true and that all statements made on information and
23 belief are believed to be true; and further that these statements were
24 made with the knowledge that willful false statements and the like so

1 made are punishable by fine or imprisonment, or both, under
2 Section 1001 of Title 18 of the United States Code and that such willful
3 false statement may jeopardize the validity of the application or any
4 patent issued therefrom.

5 * * * * *

6 Full name of sole inventor: Eugene P. Marsh

7 Inventor's Signature: Eugene P. Marsh

8 Date: 8/24/98

9 Residence: Boise, Idaho

10 Citizenship: U.S.

11 Post Office Address: 1722 Picabo Ct., Boise, ID 83716

606707-52972460